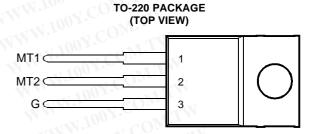
- **Sensitive Gate Triacs**
- 8 A RMS, 70 A Peak
- **Glass Passivated Wafer**
- 400 V to 800 V Off-State Voltage
- Max I_{GT} of 5 mA (Quadrant 1)



Pin 2 is in electrical contact with the mounting base.

MDC2ACA

absolute maximum ratings over operating case temperature (unless otherwise noted)

RATING			VALUE	UNIT	
Repetitive peak off-state voltage (see Note 1)	TIC225D TIC225M TIC225S TIC225N	V_{DRM}	400 600 700 800	V	
Full-cycle RMS on-state current at (or below) 70°C case temperature (see Note 2)			8	Α	
Peak on-state surge current full-sine-wave (see Note 3)		I _{TSM}	70	Α	
Peak on-state surge current half-sine-wave (see Note 4)			80	Α	
Peak gate current			(O)±1	Α	
Peak gate power dissipation at (or below) 85°C case temperature (pulse width ≤ 200 μs)			2.2	W	
Average gate power dissipation at (or below) 85°C case temperature (see Note 5)			0.9	W	
Operating case temperature range			-40 to +110	°C	
Storage temperature range			-40 to +125	°C	
Lead temperature 1.6 mm from case for 10 seconds			230	°C	

- NOTES: 1. These values apply bidirectionally for any value of resistance between the gate and Main Terminal 1.
 - 2. This value applies for 50-Hz full-sine-wave operation with resistive load. Above 70°C derate linearly to 110°C case temperature at the rate of 200 mA/°C.
 - 3. This value applies for one 50-Hz full-sine-wave when the device is operating at (or below) the rated value of on-state current. Surge may be repeated after the device has returned to original thermal equilibrium. During the surge, gate control may be lost.
 - 4. This value applies for one 50-Hz half-sine-wave when the device is operating at (or below) the rated value of on-state current. Surge may be repeated after the device has returned to original thermal equilibrium. During the surge, gate control may be lost.
 - 5. This value applies for a maximum averaging time of 20 ms.

electrical characteristics at 25°C case temperature (unless otherwise noted)

	PARAMETER	OY.C. M.TW	TEST CONDITION	ONS	MIN	TYP	MAX	UNIT
I _{DRM}	Repetitive peak off-state current	V _D = rated V _{DRM}	I _G = 0	T _C = 110°C	N	4/1	±2	mA
I _{GTM}		V _{supply} = +12 V†	$R_L = 10 \Omega$	t _{p(g)} > 20 μs	- 1	0.8	5	UU - 1
	Peak gate trigger	$V_{\text{supply}} = +12 \text{ V}\dagger$	$R_L = 10 \Omega$	$t_{p(g)} > 20 \mu s$	TW	-4.5	-20	1007
	current	V _{supply} = -12 V†	$R_L = 10 \Omega$	t _{p(g)} > 20 μs	WW	-3.5	-10	mA
		$V_{\text{supply}} = -12 \text{ V} \dagger$	$R_L = 10 \Omega$	t _{p(g)} > 20 μs		11.7	30	
V_{GTM}	MW	V _{supply} = +12 V†	$R_L = 10 \Omega$	t _{p(g)} > 20 μs	1111	0.7	2	x 10°
	Peak gate trigger	$V_{\text{supply}} = +12 \text{ V}\dagger$	$R_L = 10 \Omega$	t _{p(g)} > 20 μs	W	-0.7	-2	V
	voltage	$V_{\text{supply}} = -12 \text{ V}\dagger$	$R_L = 10 \Omega$	t _{p(g)} > 20 μs	DIVI-	-0.8	-2	N.
		$V_{\text{supply}} = -12 \text{ V}^{\dagger}$	$R_L = 10 \Omega$	t _{p(g)} > 20 μs	TIM	0.9	2	

[†] All voltages are with respect to Main Terminal 1.



electrical characteristics at 25°C case temperature (unless otherwise noted) (continued)

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
V _{TM}	Peak on-state voltage	I _{TM} = ±12 A	I _G = 50 mA	(see Note 6)		±1.6	±2.1	V
H) M	Holding current	$V_{\text{supply}} = +12 \text{ V}^{\dagger}$ $V_{\text{supply}} = -12 \text{ V}^{\dagger}$	$I_{G} = 0$ $I_{G} = 0$	Init' $I_{TM} = 100 \text{ mA}$ Init' $I_{TM} = -100 \text{ mA}$	TW	3 -4.7	20 -20	mA
·FO	Latching current	$V_{\text{supply}} = +12 \text{ V}^{\dagger}$ $V_{\text{supply}} = -12 \text{ V}^{\dagger}$	(see Note 7)	MAN TOON CO.	WT.I	ſ	30 -30	mA
dv/dt	Critical rate of rise of off-state voltage	V _{DRM} = Rated V _{DRM}	$I_G = 0$	T _C = 110°C	MIT	±50		V/µs
dv/dt _(c)	Critical rise of commutation voltage	V _{DRM} = Rated V _{DRM}	I _{TRM} = ±12 A	T _C = 70°C	±1	±1.5	±4.5	V/µs

[†] All voltages are with respect to Main Terminal 1.

thermal characteristics

	PARAMETER			MAX	UNIT	
$R_{\theta JC}$	Junction to case thermal resistance	1007.	-01	2.5	°C/W	
$R_{\theta JA}$	Junction to free air thermal resistance	4003	Co	62.5	°C/W	

TYPICAL CHARACTERISTICS

0-1

-60

-40

VS **CASE TEMPERATURE** 1000 $V_{\Delta\Delta} = \pm 12 \text{ V}$ $R_L = 10 \Omega$ _{вт} - Gate Trigger Current - mA t_{p(g)} = 20 μs 100 10 -60 -40 -20 20 40 60 100 120 T_c - Case Temperature - °C Figure 1.

GATE TRIGGER CURRENT

TC07AB 10 V_{supply} I_{GTM} + + } R_L = 10 Ω - + + Tourned TC07AB

GATE TRIGGER VOLTAGE

vs

PRODUCT INFORMATION

勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

T_c - Case Temperature - °C

Figure 2.

120

100

80

NOTES: 6. This parameter must be measured using pulse techniques, $t_p = \le 1$ ms, duty cycle ≤ 2 %. Voltage-sensing contacts separate from the current carrying contacts are located within 3.2 mm from the device body.

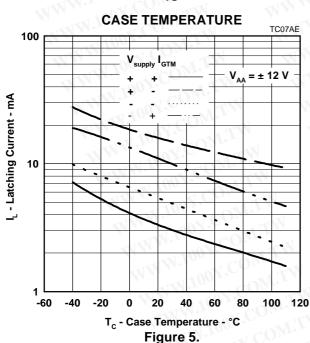
^{7.} The triacs are triggered by a 15-V (open-circuit amplitude) pulse supplied by a generator with the following characteristics: $R_G = 100 \ \Omega$, $t_{p(q)} = 20 \ \mu s$, $t_r = \le 15 \ ns$, $f = 1 \ kHz$

TYPICAL CHARACTERISTICS

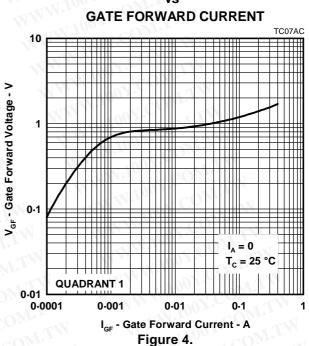
HOLDING CURRENT VS **CASE TEMPERATURE** TC07AD 100 V_{supply} - Holding Current - mA 10 1 $V_{AA} = \pm 12 V$ $I_G = 0$ Initiating $I_{TM} = 100 \text{ mA}$ 0.1 -20 80 -60 -40 0 20 40 60 100 120 T_c - Case Temperature - °C

LATCHING CURRENT vs

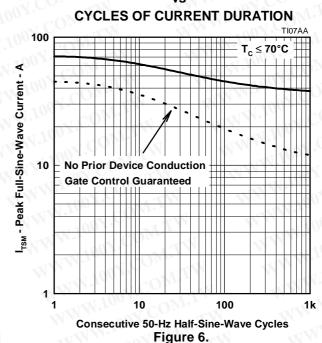
Figure 3.



GATE FORWARD VOLTAGE vs



SURGE ON-STATE CURRENT vs

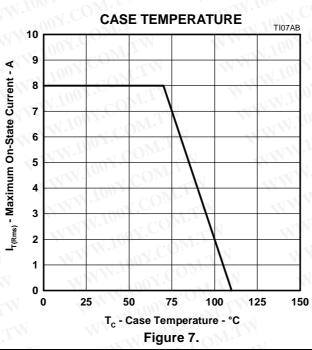




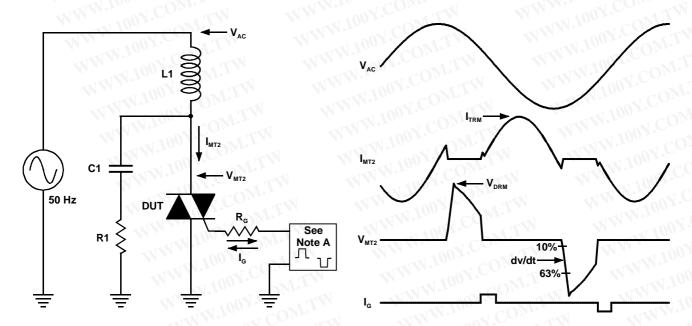
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TYPICAL CHARACTERISTICS

MAXIMUM RMS ON-STATE CURRENT vs



PARAMETER MEASUREMENT INFORMATION



NOTE A: The gate-current pulse is furnished by a trigger circuit which presents essentially an open circuit between pulses. The pulse is timed so that the off-state-voltage duration is approximately 800 µs.

Figure 8.

PMC2AA

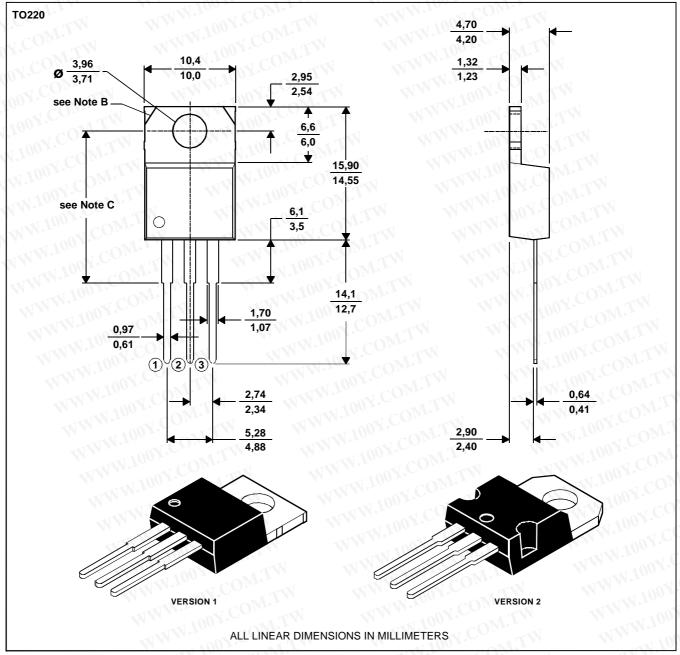
INFORMATION PRODUCT WWW.100Y.COM.TV

MECHANICAL DATA

TO-220

3-pin plastic flange-mount package

This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.



NOTES: A. The centre pin is in electrical contact with the mounting tab.

B. Mounting tab corner profile according to package version.

C. Typical fixing hole centre stand off height according to package version. Version 1, 18.0 mm. Version 2, 17.6 mm.

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